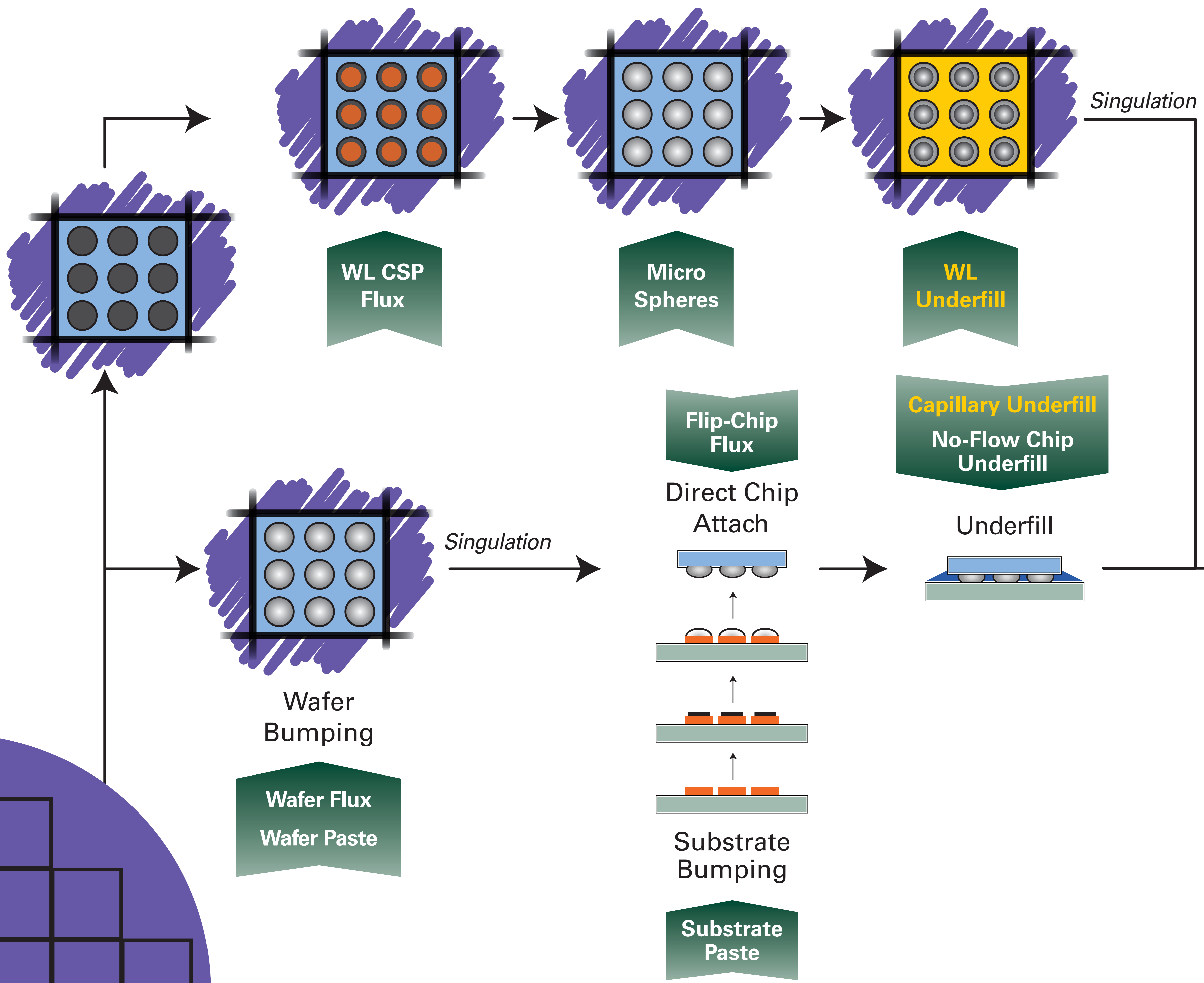
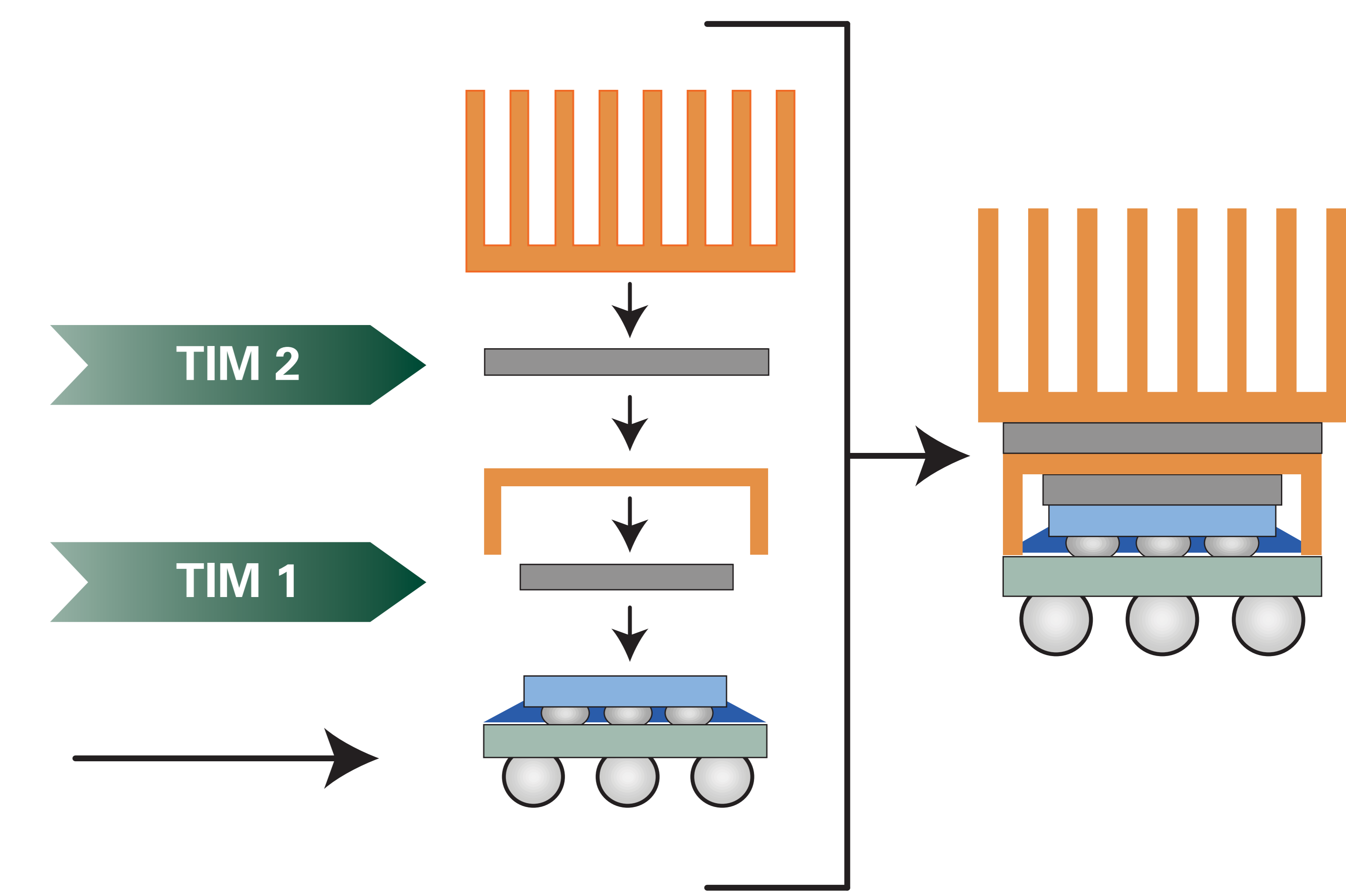


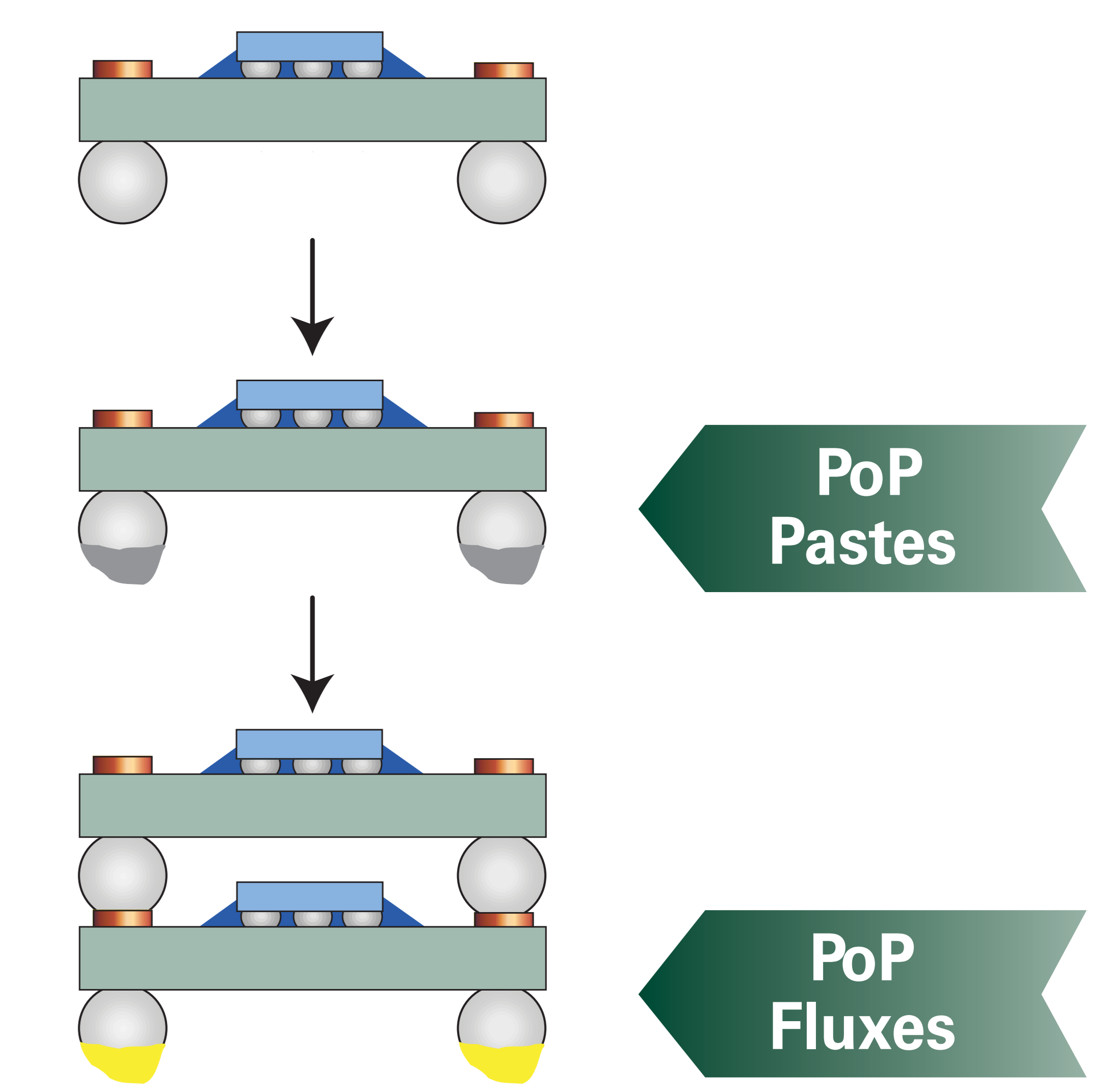
Semiconductor Packaging



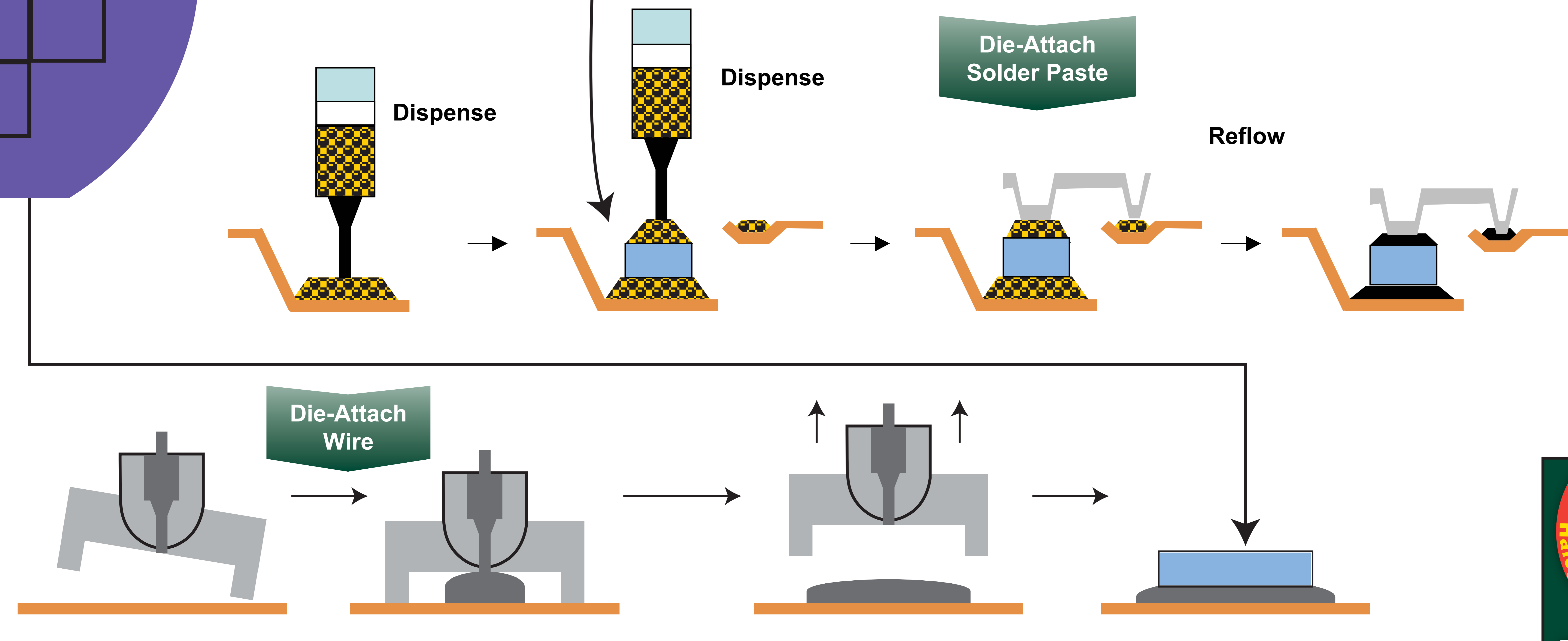
Thermal Interface Materials



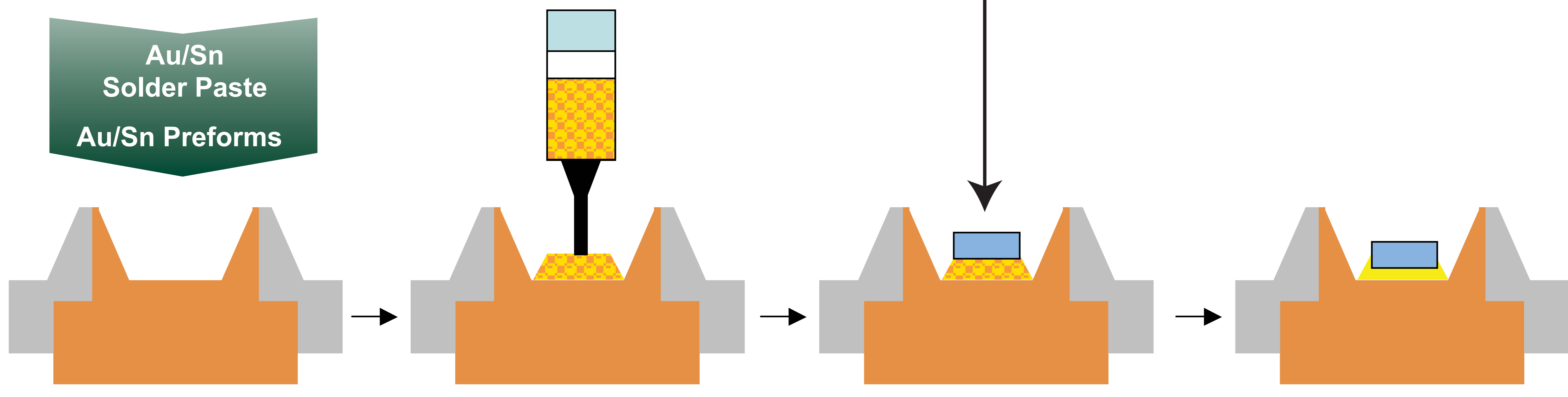
Package-on-Package (PoP) Assembly



Die-Attach



LED Manufacture



Key

Commercial Materials	Developmental Materials
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